

# MM3Z2V4T1 SERIES

## Zener Voltage Regulators

### 200 mW SOD-323 Surface Mount

This series of Zener diodes is packaged in a SOD-323 surface mount package that has a power dissipation of 200 mW. They are designed to provide voltage regulation protection and are especially attractive in situations where space is at a premium. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

#### Specification Features:

- Standard Zener Breakdown Voltage Range – 2.4 V to 75 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions:  
0.067" x 0.049" (1.7 mm x 1.25 mm)
- Low Body Height: 0.035" (0.9 mm)
- Package Weight: 4.507 mg/unit
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Pb-Free Package is Available

#### Mechanical Characteristics:

**CASE:** Void-free, transfer-molded plastic

**FINISH:** All external surfaces are corrosion resistant

#### MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

**LEADS:** Plated with Pb-Sn or Sn only (Pb-Free)

**POLARITY:** Cathode indicated by polarity band

**FLAMMABILITY RATING:** UL 94 V-0

**MOUNTING POSITION:** Any

#### MAXIMUM RATINGS

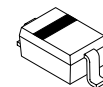
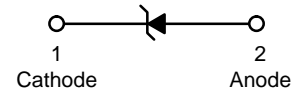
Rating	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200 1.5	mW mW/°C
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature Range	$T_J, T_{stg}$	-65 to +150	°C

1. FR-4 Minimum Pad



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<http://onsemi.com>



SOD-323  
CASE 477

#### MARKING DIAGRAM



xx = Specific Device Code  
M = Date Code

#### ORDERING INFORMATION

Device	Package	Shipping†
MM3ZxxxT1	SOD-323	3000/Tape & Reel
MM3ZxxxT1G	SOD-323 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### DEVICE MARKING INFORMATION

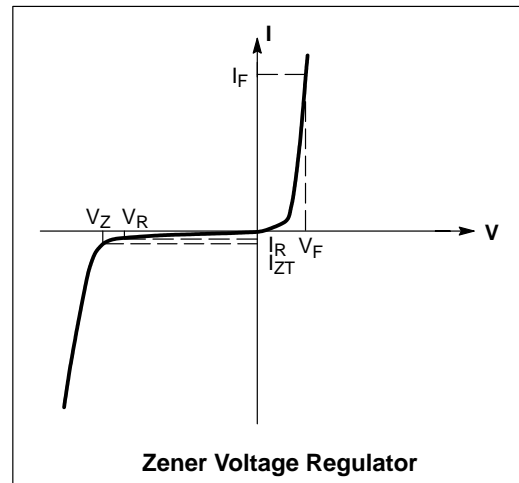
See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

## MM3Z2V4T1 SERIES

### ELECTRICAL CHARACTERISTICS

( $T_A = 25^\circ\text{C}$  unless otherwise noted,  
 $V_F = 0.9\text{ V Max. @ } I_F = 10\text{ mA}$  for all types)

Symbol	Parameter
$V_Z$	Reverse Zener Voltage @ $I_{ZT}$
$I_{ZT}$	Reverse Current
$Z_{ZT}$	Maximum Zener Impedance @ $I_{ZT}$
$I_{ZK}$	Reverse Current
$Z_{ZK}$	Maximum Zener Impedance @ $I_{ZK}$
$I_R$	Reverse Leakage Current @ $V_R$
$V_R$	Reverse Voltage
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$
$\Theta V_Z$	Maximum Temperature Coefficient of $V_Z$
C	Max. Capacitance @ $V_R = 0$ and $f = 1\text{ MHz}$



# MM3Z2V4T1 SERIES

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted,  $V_F = 0.9\text{ V Max.}$  @  $I_F = 10\text{ mA}$  for all types)

Device	Device Marking	Zener Voltage (Note 2)			Zener Impedance			Leakage Current		$\theta V_Z$ (mV/k) @ $I_{ZT}$		C @ $V_R = 0$ f = 1 MHz	
		$V_Z$ (Volts)			$@ I_{ZT}$	$Z_{ZT}$ @ $I_{ZT}$	$Z_{ZK}$ @ $I_{ZK}$		$I_R$ @ $V_R$		Min	Max	pF
		Min	Nom	Max	mA	$\Omega$	$\Omega$	mA	$\mu\text{A}$	Volts			
MM3Z2V4T1	00	2.2	2.4	2.6	5	100	1000	0.5	50	1.0	-3.5	0	450
MM3Z2V7T1	01	2.5	2.7	2.9	5	100	1000	0.5	20	1.0	-3.5	0	450
MM3Z3V0T1	02	2.8	3.0	3.2	5	100	1000	0.5	10	1.0	-3.5	0	450
MM3Z3V3T1	05	3.1	3.3	3.5	5	95	1000	0.5	5	1.0	-3.5	0	450
MM3Z3V6T1	06	3.4	3.6	3.8	5	90	1000	0.5	5	1.0	-3.5	0	450
MM3Z3V9T1	07	3.7	3.9	4.1	5	90	1000	0.5	3	1.0	-3.5	-2.5	450
MM3Z4V3T1	08	4.0	4.3	4.6	5	90	1000	0.5	3	1.0	-3.5	0	450
MM3Z4V7T1	09	4.4	4.7	5.0	5	80	800	0.5	3	2.0	-3.5	0.2	260
MM3Z5V1T1	0A	4.8	5.1	5.4	5	60	500	0.5	2	2.0	-2.7	1.2	225
MM3Z5V6T1	0C	5.2	5.6	6.0	5	40	200	0.5	1	2.0	-2.0	2.5	200
MM3Z6V2T1	0E	5.8	6.2	6.6	5	10	100	0.5	3	4.0	0.4	3.7	185
MM3Z6V8T1	0F	6.4	6.8	7.2	5	15	160	0.5	2	4.0	1.2	4.5	155
MM3Z7V5T1	0G	7.0	7.5	7.9	5	15	160	0.5	1	5.0	2.5	5.3	140
MM3Z8V2T1	0H	7.7	8.2	8.7	5	15	160	0.5	0.7	5.0	3.2	6.2	135
MM3Z9V1T1	0K	8.5	9.1	9.6	5	15	160	0.5	0.2	7.0	3.8	7.0	130
MM3Z10VT1	0L	9.4	10	10.6	5	20	160	0.5	0.1	8.0	4.5	8.0	130
MM3Z11VT1	0M	10.4	11	11.6	5	20	160	0.5	0.1	8.0	5.4	9.0	130
MM3Z12VT1	0N	11.4	12	12.7	5	25	80	0.5	0.1	8.0	6.0	10	130
MM3Z13VT1	0P	12.4	13.25	14.1	5	30	80	0.5	0.1	8.0	7.0	11	120
MM3Z15VT1	0T	14.3	15	15.8	5	30	80	0.5	0.05	10.5	9.2	13	110
MM3Z16VT1	0U	15.3	16.2	17.1	5	40	80	0.5	0.05	11.2	10.4	14	105
MM3Z18VT1	0W	16.8	18	19.1	5	45	80	0.5	0.05	12.6	12.4	16	100
MM3Z20VT1	0Z	18.8	20	21.2	5	55	100	0.5	0.05	14.0	14.4	18	85
MM3Z22VT1	10	20.8	22	23.3	5	55	100	0.5	0.05	15.4	16.4	20	85
MM3Z24VT1	11	22.8	24.2	25.6	5	70	120	0.5	0.05	16.8	18.4	22	80
MM3Z27VT1	12	25.1	27	28.9	2	80	300	0.5	0.05	18.9	21.4	25.3	70
MM3Z30VT1	14	28	30	32	2	80	300	0.5	0.05	21.0	24.4	29.4	70
MM3Z33VT1	18	31	33	35	2	80	300	0.5	0.05	23.2	27.4	33.4	70
MM3Z36VT1	19	34	36	38	2	90	500	0.5	0.05	25.2	30.4	37.4	70
MM3Z39VT1	20	37	39	41	2	130	500	0.5	0.05	27.3	33.4	41.2	45
MM3Z43VT1	21	40	43	46	2	150	500	0.5	0.05	30.1	37.6	46.6	40
MM3Z47VT1	1A	44	47	50	2	170	500	0.5	0.05	32.9	42.0	51.8	40
MM3Z51VT1	1C	48	51	54	2	180	500	0.5	0.05	35.7	46.6	57.2	40
MM3Z56VT1	1D	52	56	60	2	200	500	0.5	0.05	39.2	52.2	63.8	40
MM3Z62VT1	1E	58	62	66	2	215	500	0.5	0.05	43.4	58.8	71.6	35
MM3Z68VT1	1F	64	68	72	2	240	500	0.5	0.05	47.6	65.6	79.8	35
MM3Z75VT1	1G	70	75	79	2	255	500	0.5	0.05	52.5	73.4	88.6	35

2. Zener voltage is measured with a pulse test current  $I_Z$  at an ambient temperature of  $25^\circ\text{C}$ .

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## TYPICAL CHARACTERISTICS

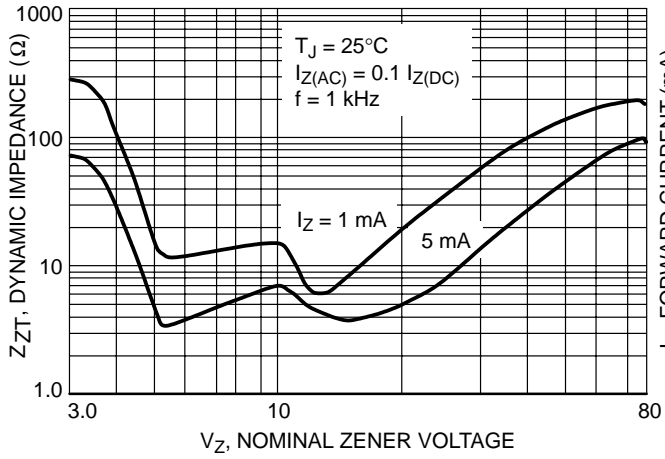


Figure 1. Effect of Zener Voltage on Zener Impedance

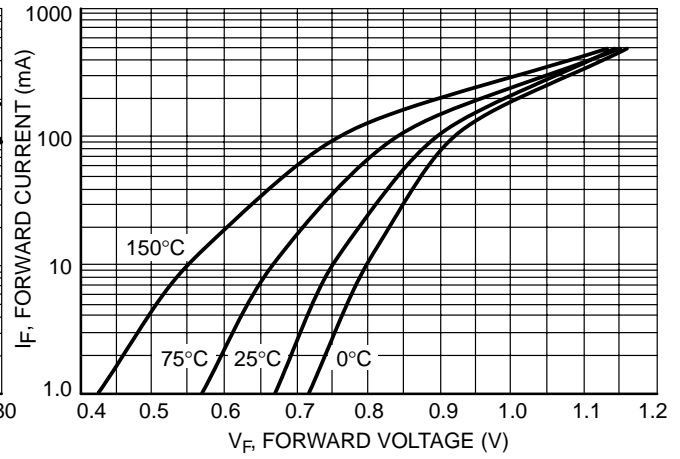


Figure 2. Typical Forward Voltage

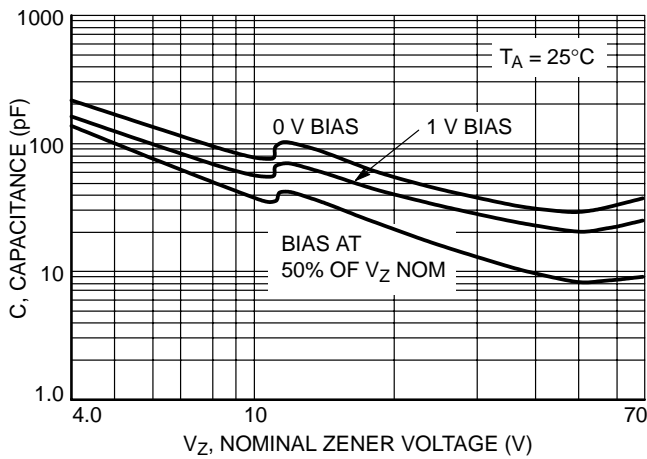


Figure 3. Typical Capacitance

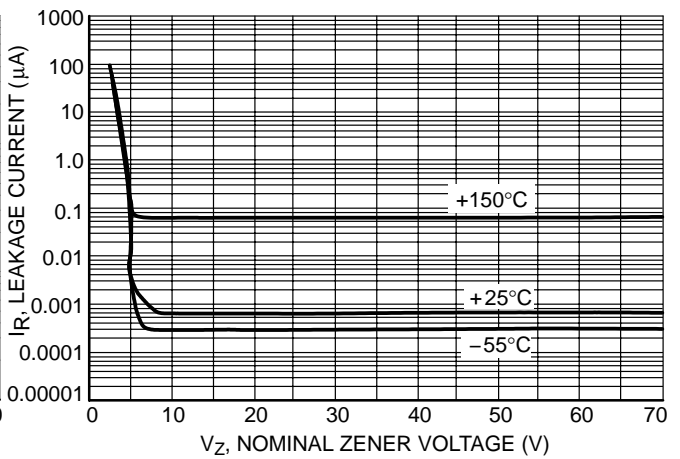


Figure 4. Typical Leakage Current

# MM3Z2V4T1 SERIES

## TYPICAL CHARACTERISTICS

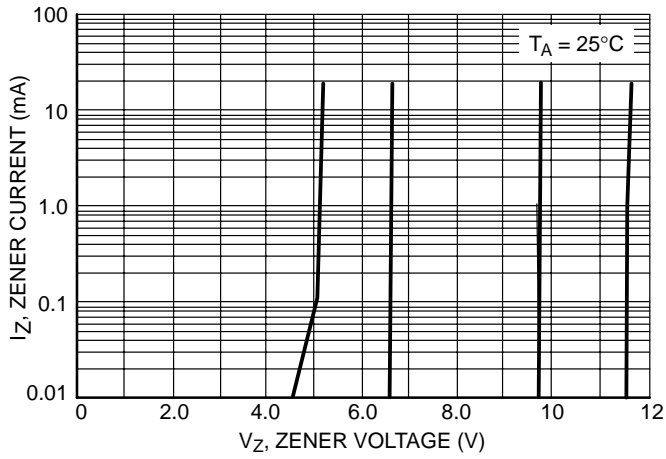


Figure 5. Zener Voltage versus Zener Current ( $V_Z$  Up to 12 V)

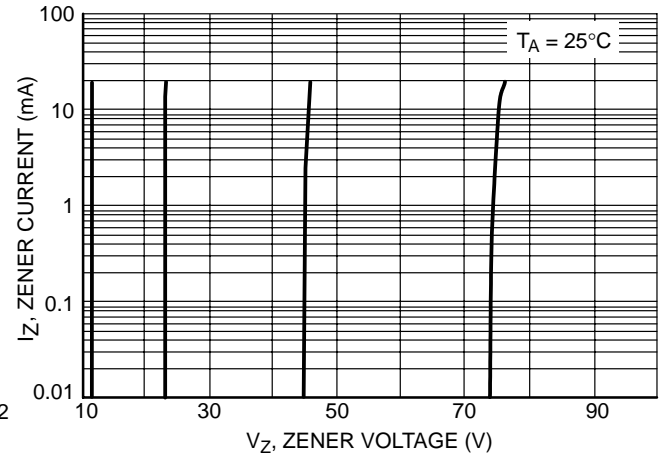


Figure 6. Zener Voltage versus Zener Current (12 V to 75 V)

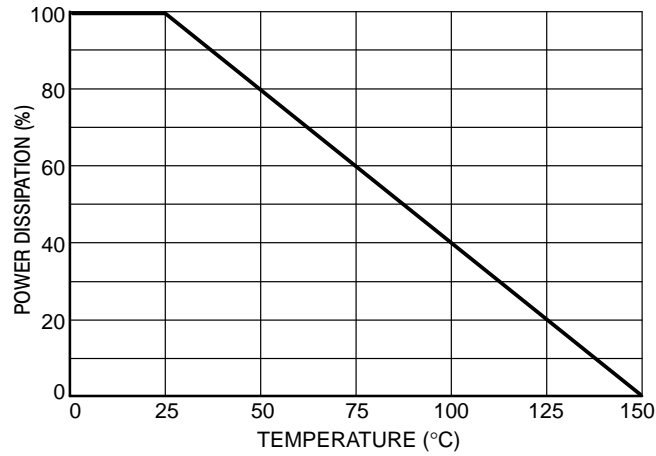
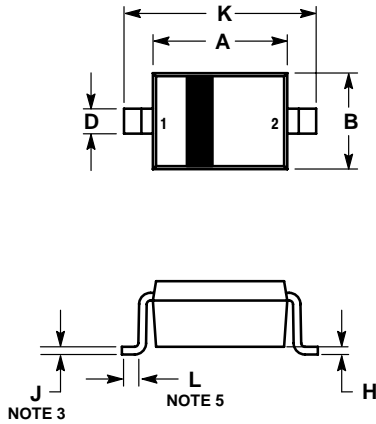


Figure 7. Steady State Power Derating

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## PACKAGE DIMENSIONS

SOD-323  
CASE 477-02  
ISSUE D



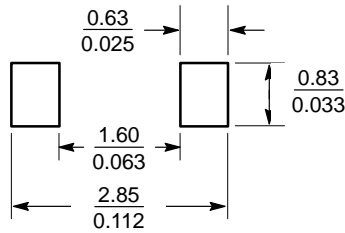
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DIMENSION L IS MEASURED FROM END OF RADIUS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.60	1.80	0.063	0.071
B	1.15	1.35	0.045	0.053
C	0.80	1.00	0.031	0.039
D	0.25	0.40	0.010	0.016
E	0.15 REF		0.006 REF	
H	0.00	0.10	0.000	0.004
J	0.089	0.177	0.0035	0.0070
K	2.30	2.70	0.091	0.106
L	0.075	---	0.003	---


STYLE 1:  
PIN 1. CATHODE  
2. ANODE

### SOLDERING FOOTPRINT\*



SCALE 10:1 (mm / inches)

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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